### 查<mark>询"FDMS7660AS"</mark>供应商 FAIRCHILD

SEMICONDUCTOR®

# September 2009

## **FDMS7660AS** N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup> 30 V, 42 A, 2.4 m $\Omega$

### Features

- Max r<sub>DS(on)</sub> = 2.4 mΩ at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 25 A
- Max  $r_{DS(on)}$  = 2.6 m $\Omega$  at V<sub>GS</sub> = 7 V, I<sub>D</sub> = 23 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

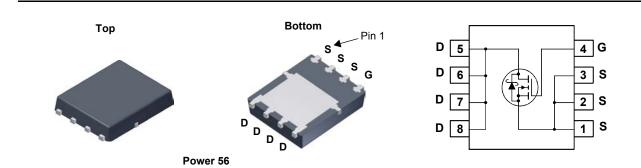


### **General Description**

The FDMS7660AS has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest  $r_{DS(on)}$  while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

### Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



### **MOSFET Maximum Ratings** $T_C = 25$ °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		42		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		152	A	
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	26	A	
	-Pulsed			150		
dv/dt	MOSFET dv/dt			1.7	V/ns	
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 3)		(Note 3)	128	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		83	w	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature R	ange		-55 to +150	°C	

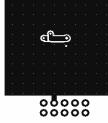
### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.5	°C/W	]
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/W	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7660AS	FDMS7660AS	Power 56	13 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V	30			V	
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D$ = 10 mA, referenced to 25 °C		14		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			500	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS}$ = 20 V, $V_{DS}$ = 0 V			100	nA	
On Chara	cteristics (Note 2)						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 1 \text{ mA}$	1.2	1.9	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		-5		mV/°C	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25 A		1.9	2.4	mΩ	
-	Statia Drain to Source On Desistance	V <sub>GS</sub> = 7 V, I <sub>D</sub> = 23 A		2.0	2.6		
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 21 A		2.5	3.0		
		$V_{GS}$ = 10 V, I <sub>D</sub> = 25 A, T <sub>J</sub> = 125 °C		2.4	3.1		
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 25 A		455		S	
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance			4600	6120	pF	
C <sub>oss</sub>	Output Capacitance	− V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, – f = 1 MHz		1550	2065	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			125	190	pF	
R <sub>g</sub>	Gate Resistance			0.8	1.7	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			19	34	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 25 A,		8	15	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		40	65	ns	
t <sub>f</sub>	Fall Time	-		5	10	ns	
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		64	90	nC	
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$		29	42	nC	
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 25 A		14.4		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			5.9		nC	
Drain-Soເ	arce Diode Characteristics						
V	Source to Drain Diede, Eenward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.41	0.7	V	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 25 A$ (Note 2)		0.76	1.2	v	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 25 A, di/dt = 300 A/μs		39	62	ns	
Q <sub>rr</sub>	Reverse Recovery Charge			55	88	nC	



a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

b. 125 °C/W when mounted on a minimum pad of 2 oz copper.



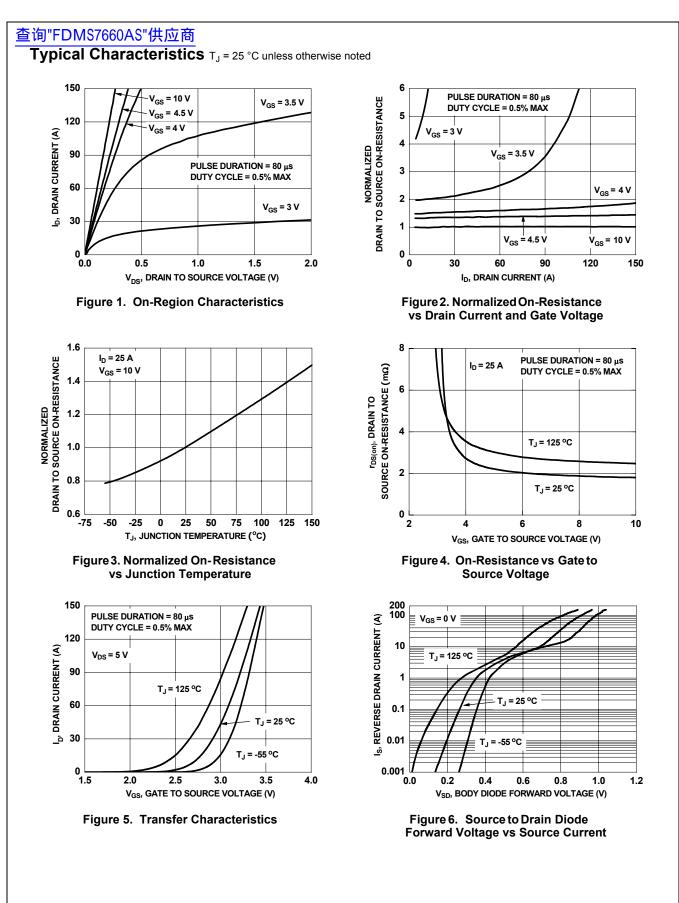
2. Pulse Test: Pulse Width < 300  $\mu\text{s},$  Duty cycle < 2.0%.

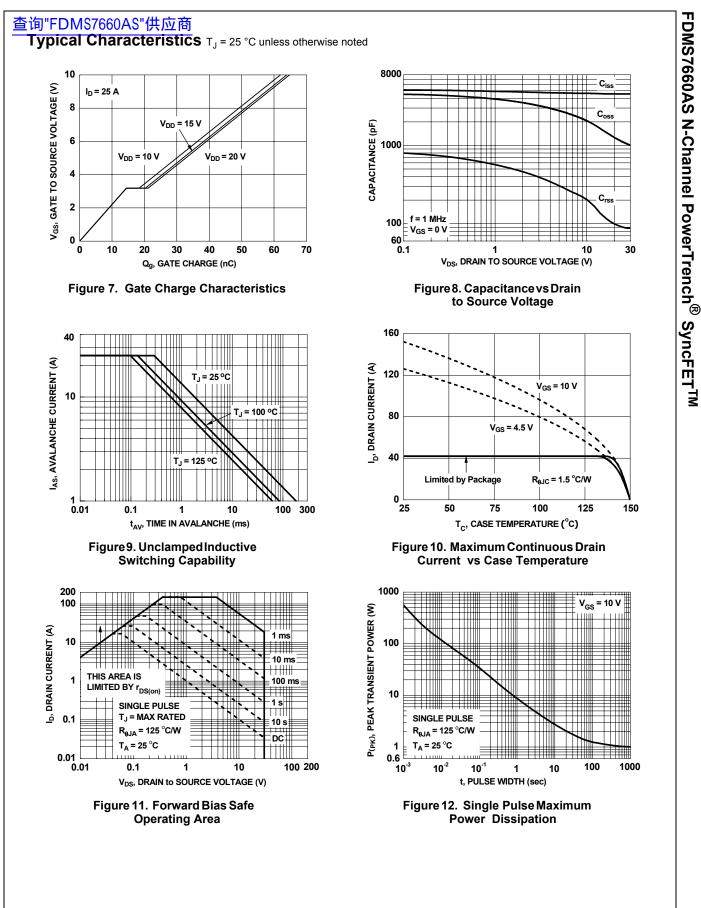
3.  $E_{AS}$  of 128 mJ is based on starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 16 A,  $V_{DD}$  = 27 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 25 A.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

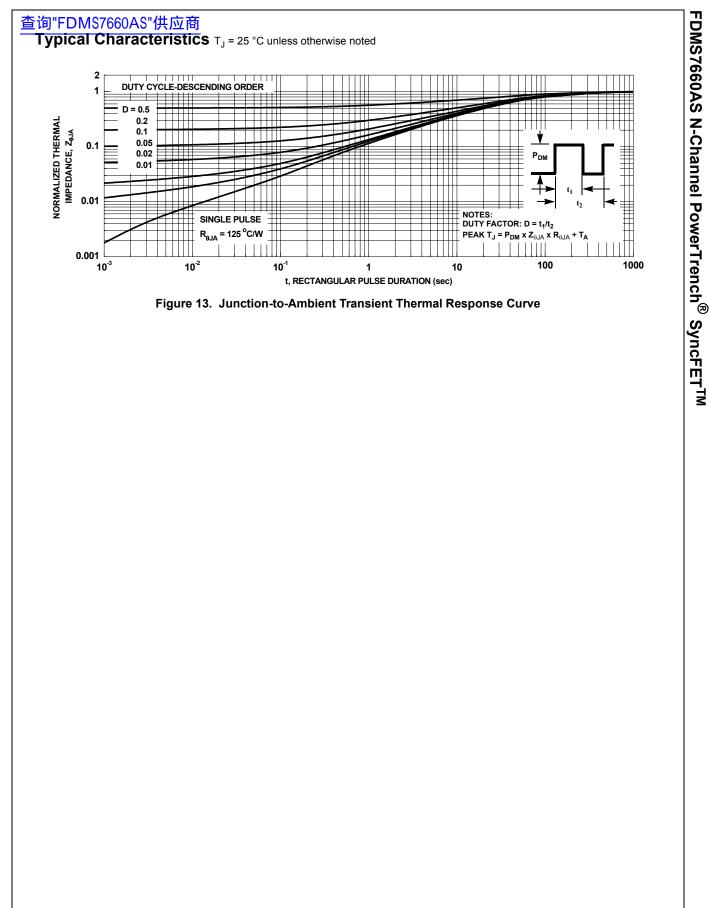
FDMS7660AS N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup>

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FDMS7660AS Rev.C



# FDMS7660AS N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup>

### 查询"FDMS7660AS"供应商 Typical Characteristics (continued)

### SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS7660AS.

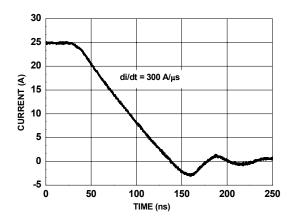
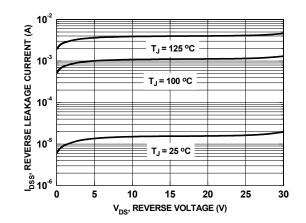
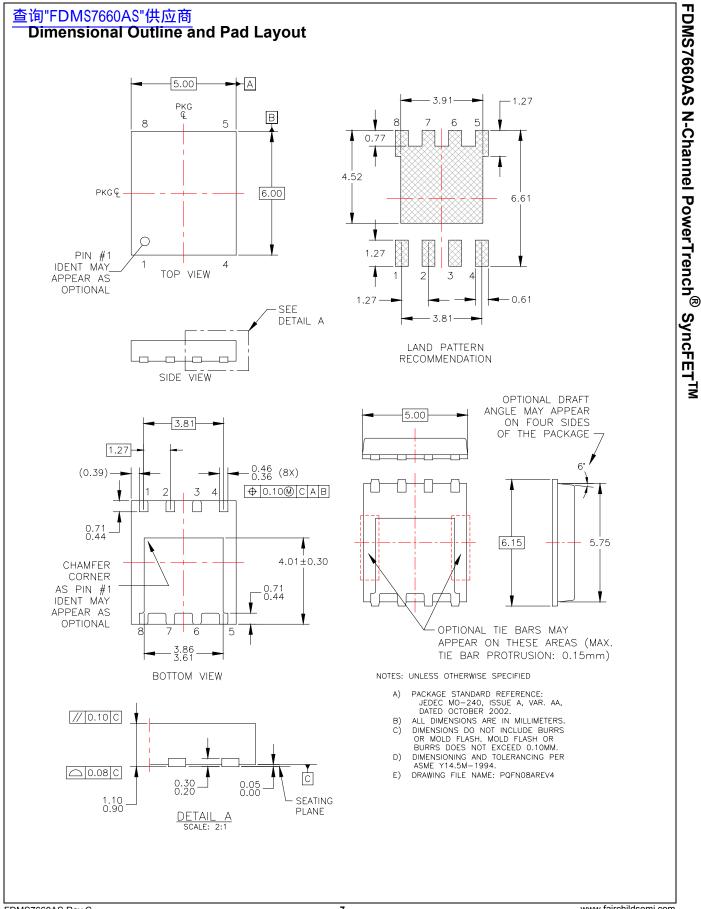


Figure 14. FDMS7660AS SyncFET body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.



# Figure 15. SyncFET body diode reverses leakage versus drain-source voltage



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